TOSHIBA Photocoupler Photorelay

# **TLP192G**

PC Card Modems
PBX
STB (Set Top Boxes)
Measurement Equipment

The Toshiba TLP192G consists of a gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a 6-pin SOP package.

This photorelay has a characteristic of high-withstanding voltage between output pins which enables TLP192G to be applied in hook relays and dial-pulse for modems and facsimiles.

Moreover, the TLP192G is used for PCMCIA-compliant card modems because the maximum mounted height of SOP package is as small as 2.1 mm.

• 6-pin SOP (2.54SOP4): Height = 2.1 mm, Pitch = 2.54 mm

• Normally open (1-form-A) device

• Peak Off-state voltage: 350 V (min)

• Trigger LED current: 3 mA (max)

• On-state current: 110 mA (max)

• On-state resistance:  $35 \Omega$  (max, t < 1 s)

• On-state resistance:  $50 \Omega$  (max, continuous)

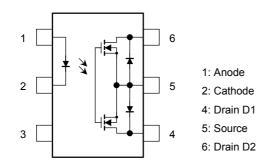
• Isolation voltage: 1500 Vrms (min)

• UL recognized: UL1557, File No.E67349

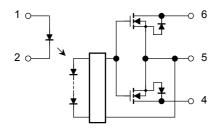
# JEDEC — JEITA — TOSHIBA 11-7C1

Weight: 0.2 g (typ.)

### Pin Configuration (top view)



### **Schematic**



# Maximum Rating (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
	Forward current	l <sub>F</sub>	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C
LED	Reverse voltage	V <sub>R</sub>	5	V
	Junction temperature	Tj	125	°C
	Off-state output terminal voltage	V <sub>OFF</sub>	350	V
	On-state current	I <sub>ON</sub>	110	mA
Detector	Forward current derating (Ta ≥ 25°C)	Δl <sub>ON</sub> /°C	-1.1	mA/°C
	Junction temperature	Tj	125	°C
Storage temperature range		T <sub>stg</sub>	-55~125	°C
Operating temperature range		T <sub>opr</sub>	T <sub>opr</sub> -40~85	
Lead soldering temperature (10 s)		T <sub>sol</sub>	260	°C
Isolation voltage (AC, 1 min, R.H. ≦ 60%) (Note 1)		BVS	1500	Vrms

Note 1: LED pins are shorted together. Detector pins are also shorted together.

### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	_	280	V
Forward current	I <sub>F</sub>	5	10	25	mA
On-state current	I <sub>ON</sub>	_	_	100	mA
Operating temperature	T <sub>opr</sub>	-20	_	65	°C

## **Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μА
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MHz	_	30	_	pF
Detector	Off-state current	l <sub>OFF</sub>	V <sub>OFF</sub> = 350 V	_	_	1	μА
Detector	Capacitance	C <sub>OFF</sub>	V = 0, f = 1 MHz	_	30	_	pF

2

## **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I <sub>FT</sub>	I <sub>ON</sub> = 110 mA	_	1	3	mA
Return LED current		I <sub>FC</sub>	I <sub>OFF</sub> = 100 μA	0.1	_	_	mA
On-state resistance	A connection	R <sub>ON</sub>	I <sub>ON</sub> = 110 mA, I <sub>F</sub> = 5 mA, t < 1 s	_	25	35	Ω
	A connection		I <sub>ON</sub> = 110 mA, I <sub>F</sub> = 5 mA		35	50	
	B connection		I <sub>ON</sub> = 110 mA, I <sub>F</sub> = 5 mA		28	40	5.2
	C connection		I <sub>ON</sub> = 220 mA, I <sub>F</sub> = 5 mA	_	14	20	

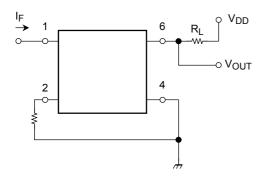
## **Switching Characteristics (Ta = 25°C)**

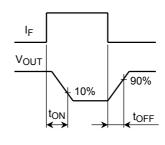
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	C <sub>S</sub>	V <sub>S</sub> = 0 V, f = 1 MHz	_	8.0	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≦ 60%	$5 \times 10^{10}$	10 <sup>14</sup>	_	Ω
	BVS	AC, 1 min	1500	_	_	Vrms
Isolation voltage		AC, 1 s, in oil	_	3000	_	
		DC, 1 min, in oil	_	3000	_	Vdc

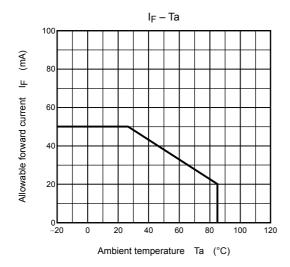
## **Switching Characteristics (Ta = 25°C)**

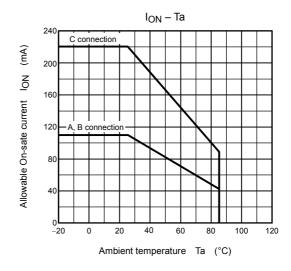
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t <sub>ON</sub>	$R_L = 200 \Omega$	_	0.3	1	ms
Turn-off time	t <sub>OFF</sub>	$V_{DD} = 20 \text{ V, I}_F = 5 \text{ mA}$ (Note 2)	_	0.1	1	1115

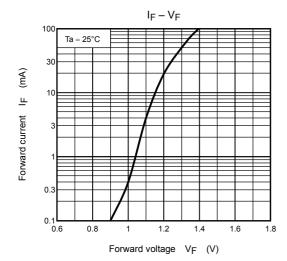
Note 2: Switching time test circuit

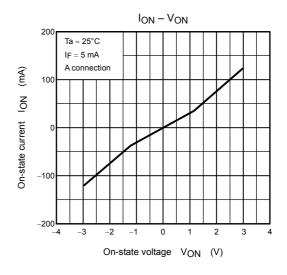


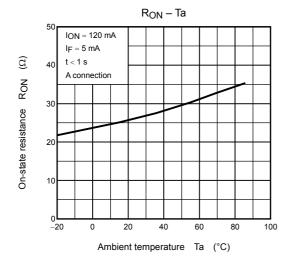


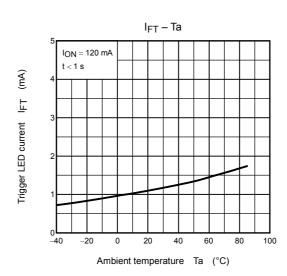


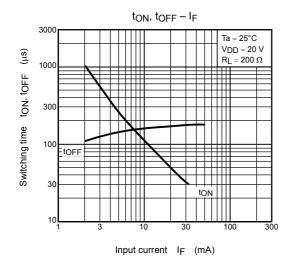


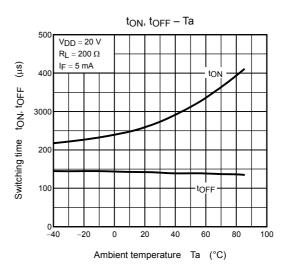


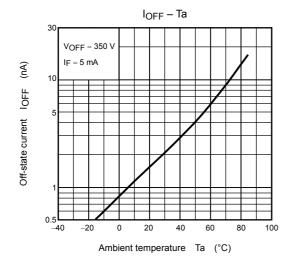












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